

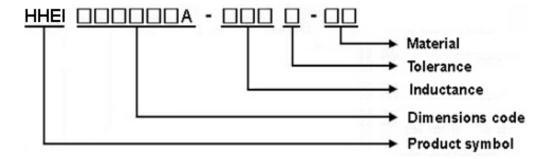
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer :			
Customer P/N:			
Drawing No:			
Quantity:	X Pcs	s. DATE:	2016/08/17
Chilisin P/N:	—— н	– IHEI252010A-1	R0M-Q8
		ICATION TED BY:	
COMPONENT			
ENGINEER			
ELECTRICAL ENGINEER			
MECHANICAL			
ENGINEER			
APPROVED			
REJECTED			
奇力新電子股份有限公司 Chilisin Electronics Corp No. 29, Alley 301, Tehhsin Rd., Hukou, Hsinchu 303, Taiwan TEL:+886-3-599-2646 FAX:+886-3-599-9176 E-mail:sales@chilisin.com.tw http://www.chilisin.com.tw	,	東莞奇力新電子有 Chilisin Electronics (Do No. 78, Puxing Rd., Yu Area, Qingxi Town, Do Guangdong, China TEL: +86-769-8773-0 FAX: +86-769-8773-0 E-mail: cect@chilisin.	ongguan) Co., Ltd. uliangwei Administration ongguan City, 0251~3 0232
奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	o., Ltd. , area	蘇州奇益新電子有 SUZHOU QI YIXIN Ele No.143,Song Shan Rd Suzhou,China Postal Code:215129 TEL:+86-512-6841-23 FAX:+86-512-6841-23 E-mail: suzhou@chilis	ectronics Co., Ltd. d., Suzhou New District, 50 156
Drawn by 張鈺雯 chang.yuwen		eked by ang.yuwen	Approved by 鍾瑞民 jacky.chung

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (after PCB)

 $-5\,^{\circ}\mathrm{C} \sim 3\,\,5\,^{\circ}\mathrm{C}$, Humidity $4\,\,5\,\% \sim 8\,\,5\,\%$ (before PCB)

4 Marking:

No Marking

5 Standard Testing Condition

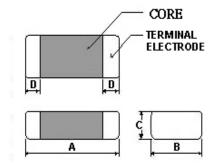
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°ℂ)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

HHEI252010A Series Specification

6 Configuration and Dimensions:



Dimensions in mm

TYPE HHE

TYPE	HHEI252010A
Α	2.5±0.3
В	2.0±0.3
С	1.0max
D	0.6±0.3

7 ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	
HHEI252010A-1R0M-Q8	1.0	20	2MHz,0.2V	4.2(4.4)	4.7(5.0)	30(25)	

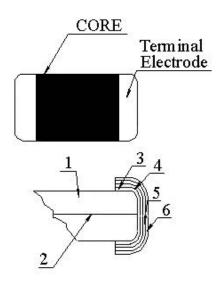
NOTE:

- 1.Operating temperature range $-4~0~\mathrm{^{\circ}C} \sim 1~2~5~\mathrm{^{\circ}C}$ (Including self temperature rise)
- 2.ldc: DC current (A) that will cause an approximate ΔT of 40°C.
- 3.Isat: DC current (A) that will cause Lo to drop approximately 30%
- 4.All test data is referenced to 25 $^{\circ}\mathrm{C}$ ambient
- 5. Absolute maximum voltage 25VDC



8 HHEI252010A Series

8.1 Construction:



8.2 Material List:

No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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HHEI252010A Series Specification 9 Reliability Of Molding power inductors

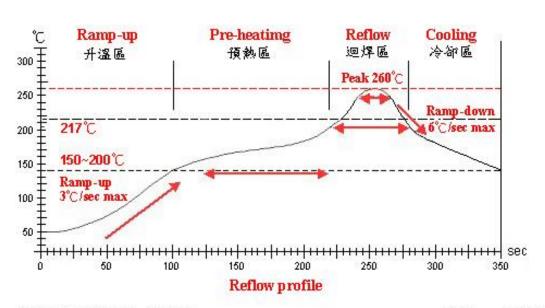
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the metal body	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for microscope of CASTOR MZ-45 20X) Inductance change shall be within ±20%	Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	l · ·	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245±5°C Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination Chip F Mounting Pad	Test device shall be soldered on the substrate, then apply a force in the direction of the arrow. Force: 5N Keeping Time: 10±1sec

1-2 Environmental Performance

No	Item	Specification		Test Method		
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:			
		Inductance:within±20% of	Step	Temperature (°ℂ)	Time (min)	
		initial value	1	-40±3	30	
			2	25±2	3	
			3	125±3	30	
			4	25±2	3	
			Total: 100d	cycles		
			Measured	after exposure in the room co	ondition for 24hrs	
1-2-2	Humidity Resistance		Temperature: 60±2°C			
			Relative Humidity: 90 ~ 95% / Time: 500hrs			
			Measured	after exposure in the room co	ondition for 24hrs	
1-2-3	High		Temperature: 85±3°C			
	Temperature Resistance		Relative Humidity: 0% / Time: 500hrs			
			Measured after exposure in the room condition for 24hrs			
1-2-4	Low		Temperatu	ıre: -40±3°ℂ		
	Temperature Resistance		Relative Humidity: 0% / Time: 500hrs			
			Measured	after exposure in the room co	ondition for 24hrs	





Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
温度範圍 Temp.scope	R.T. ~150°℃	150°C ~ 200°C	217℃	260±5°ℂ	Peak Temp. ~ 150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	3 3
實際時間 Time result		75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	8 8

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



10 Packaging

10.1 Packaging -Cover tape

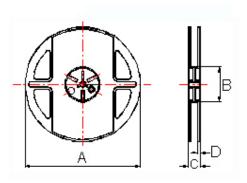
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
HHEI252010A	3000

10.3 Reel Dimensions



Dimensions in mm

TYPE	Α	В	С	D
HHEI252010A	178	60	12	1.5

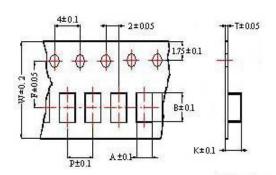


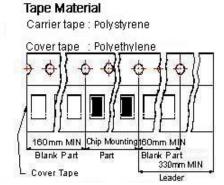
CHILISIN ELECTRONICS CORP.

HHEI252010A Series Specification

10 Packaging

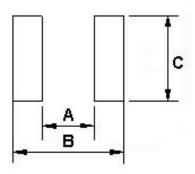
10.4 Tape Dimensions in mm





TYPE	А	В	Т	W	Р	F	K
HHEI252010A	2.25	2.80	0.22	8	4	3.5	1.15

11 Recommended Pattern



Dimensions in mm

TYPE	Α	В	С
HHEI252010A	1.2	2.8	2.3

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5.After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.



13 Graph:

